

Ultrafast Rectifier

FFPF10UP60S

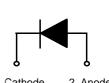
Features

- Ultrafast with soft recovery (@ I_F = 1A), < 40ns
- Reverse Voltage, 600V
- Forward Voltage (@ $T_C = 60^{\circ}C$), < 2V
- Enhanced Avalanche Energy

Applications

- General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- Power switching circuits





Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 60°C	10	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	50	А
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

Thermal Characteristics

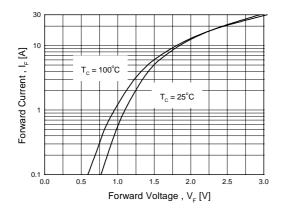
Symbol	Parameter	Value	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	4.5	°C/W

Electrical Characteristics T_C=25 °C unless otherwise noted

Symbol	Parameter		Parameter Min. Ty	Тур.	Max.	. Units
V _{FM} *	Maximum Instantaneous Forward Voltage					V
	I _F = 10A	T _C = 25 °C	-	-	2.2	
	I _F = 10A	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	-	-	2.0	
I _{RM} *	Maximum Instantaneous Reverse Current					μΑ
	@ rated V _R	$T_C = 25 ^{\circ}C$	-	-	100	
		$T_C = 25$ °C $T_C = 100$ °C	-	-	500	
t _{rr}	Reverse Recovery Time		-	34	40	ns
I _{rr}	Reverse Recovery Current		-	1.0	1.5	Α
Q _{rr}	Reverse Recovery Charge (I _F =1A, di/dt = 100A/μs)		-	17	30	nC
t _{rr}	Maximum Reverse Recovery Time (I _F =10A, di/dt = 200A/μs)		-	58	-	ns
W _{AVL}	Avalanche Energy (L=40mH)	•	20	-	-	mJ

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%

Typical Characteristics

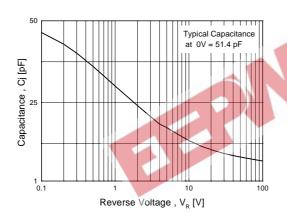


100 T_c = 100°C T_c = 100°C T_c = 25°C 100 1E-3 100 200 300 400 500 600 Reverse Voltage , V_R [V]

1000

Figure 1. Typical Forward Voltage Drop vs. Forward Current





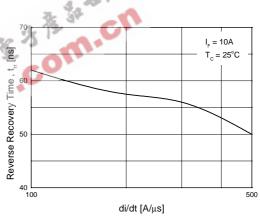
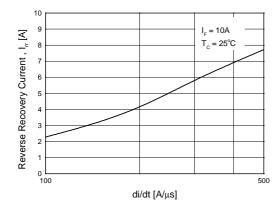


Figure 3. Typical Junction Capacitance

Figure 4. Typical Reverse Recovery Time vs. di/dt



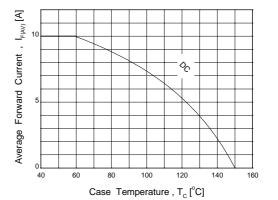
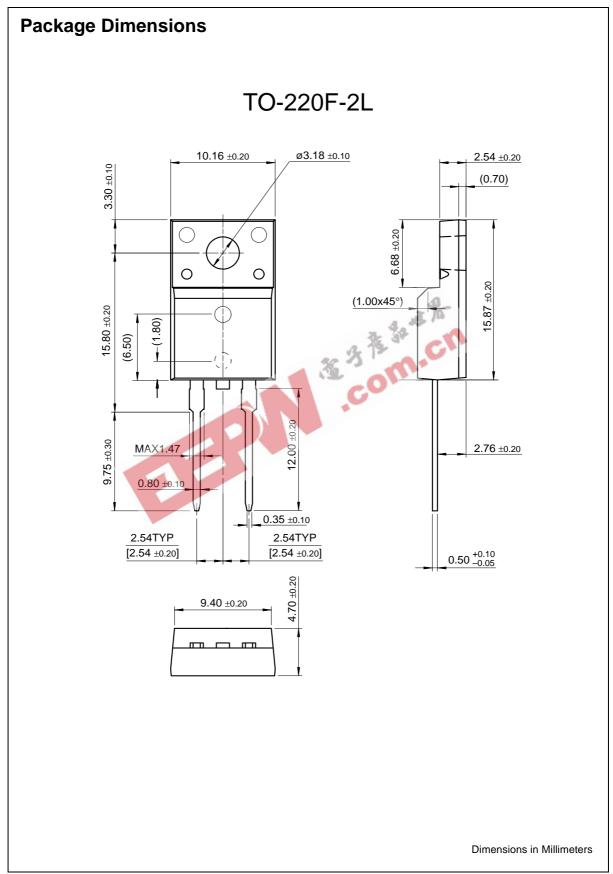


Figure 5. Typical Reverse Recovery Current vs. di/dt

Figure 6. Forward Current Derating Curve

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